

# Global Semiconductor Wafer Blade Cutting Machine Market Research Report 2023

<https://marketpublishers.com/r/G873E9EA5E75EN.html>

Date: October 2023

Pages: 135

Price: US\$ 2,900.00 (Single User License)

ID: G873E9EA5E75EN

## Abstracts

This report aims to provide a comprehensive presentation of the global market for Semiconductor Wafer Blade Cutting Machine, with both quantitative and qualitative analysis, to help readers develop business/growth strategies, assess the market competitive situation, analyze their position in the current marketplace, and make informed business decisions regarding Semiconductor Wafer Blade Cutting Machine.

The Semiconductor Wafer Blade Cutting Machine market size, estimations, and forecasts are provided in terms of output/shipments (K Units) and revenue (\$ millions), considering 2022 as the base year, with history and forecast data for the period from 2018 to 2029. This report segments the global Semiconductor Wafer Blade Cutting Machine market comprehensively. Regional market sizes, concerning products by type, by application and by players, are also provided.

For a more in-depth understanding of the market, the report provides profiles of the competitive landscape, key competitors, and their respective market ranks. The report also discusses technological trends and new product developments.

The report will help the Semiconductor Wafer Blade Cutting Machine manufacturers, new entrants, and industry chain related companies in this market with information on the revenues, production, and average price for the overall market and the sub-segments across the different segments, by company, by type, by application, and by regions.

By Company

DISCO

Tokyo Seimitsu

GL Tech Co Ltd

ASM

Synova

CETC Electronics Equipment Group Co., Ltd.

Shenyang Heyan Technology Co., Ltd.

Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd.

Hi-TESI

Tensun

### Segment by Type

150mm Wafer

200mm Wafer

300mm Wafer

### Segment by Application

Pure Foundry

IDM

OSAT

LED

Photovoltaic

## Production by Region

North America

Europe

China

Japan

## Consumption by Region

North America

United States

Canada

Europe

Germany

France

U.K.

Italy

Russia

Asia-Pacific

China

Japan

South Korea

China Taiwan

Southeast Asia

India

Latin America

Mexico

Brazil

## Core Chapters

Chapter 1: Introduces the report scope of the report, executive summary of different market segments (by region, by type, by application, etc), including the market size of each market segment, future development potential, and so on. It offers a high-level view of the current state of the market and its likely evolution in the short to mid-term, and long term.

Chapter 2: Detailed analysis of Semiconductor Wafer Blade Cutting Machine manufacturers competitive landscape, price, production and value market share, latest development plan, merger, and acquisition information, etc.

Chapter 3: Production/output, value of Semiconductor Wafer Blade Cutting Machine by region/country. It provides a quantitative analysis of the market size and development potential of each region in the next six years.

Chapter 4: Consumption of Semiconductor Wafer Blade Cutting Machine in regional level and country level. It provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and production of each country in the world.

Chapter 5: Provides the analysis of various market segments by type, covering the

market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 6: Provides the analysis of various market segments by application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 7: Provides profiles of key players, introducing the basic situation of the key companies in the market in detail, including product production/output, value, price, gross margin, product introduction, recent development, etc.

Chapter 8: Analysis of industrial chain, including the upstream and downstream of the industry.

Chapter 9: Introduces the market dynamics, latest developments of the market, the driving factors and restrictive factors of the market, the challenges and risks faced by manufacturers in the industry, and the analysis of relevant policies in the industry.

Chapter 10: The main points and conclusions of the report.

## Contents

### **1 SEMICONDUCTOR WAFER BLADE CUTTING MACHINE MARKET OVERVIEW**

#### 1.1 Product Definition

#### 1.2 Semiconductor Wafer Blade Cutting Machine Segment by Type

##### 1.2.1 Global Semiconductor Wafer Blade Cutting Machine Market Value Growth Rate Analysis by Type 2022 VS 2029

##### 1.2.2 150mm Wafer

##### 1.2.3 200mm Wafer

##### 1.2.4 300mm Wafer

#### 1.3 Semiconductor Wafer Blade Cutting Machine Segment by Application

##### 1.3.1 Global Semiconductor Wafer Blade Cutting Machine Market Value Growth Rate Analysis by Application: 2022 VS 2029

##### 1.3.2 Pure Foundry

##### 1.3.3 IDM

##### 1.3.4 OSAT

##### 1.3.5 LED

##### 1.3.6 Photovoltaic

#### 1.4 Global Market Growth Prospects

##### 1.4.1 Global Semiconductor Wafer Blade Cutting Machine Production Value Estimates and Forecasts (2018-2029)

##### 1.4.2 Global Semiconductor Wafer Blade Cutting Machine Production Capacity Estimates and Forecasts (2018-2029)

##### 1.4.3 Global Semiconductor Wafer Blade Cutting Machine Production Estimates and Forecasts (2018-2029)

##### 1.4.4 Global Semiconductor Wafer Blade Cutting Machine Market Average Price Estimates and Forecasts (2018-2029)

#### 1.5 Assumptions and Limitations

### **2 MARKET COMPETITION BY MANUFACTURERS**

#### 2.1 Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Manufacturers (2018-2023)

#### 2.2 Global Semiconductor Wafer Blade Cutting Machine Production Value Market Share by Manufacturers (2018-2023)

#### 2.3 Global Key Players of Semiconductor Wafer Blade Cutting Machine, Industry Ranking, 2021 VS 2022 VS 2023

#### 2.4 Global Semiconductor Wafer Blade Cutting Machine Market Share by Company

Type (Tier 1, Tier 2 and Tier 3)

2.5 Global Semiconductor Wafer Blade Cutting Machine Average Price by Manufacturers (2018-2023)

2.6 Global Key Manufacturers of Semiconductor Wafer Blade Cutting Machine, Manufacturing Base Distribution and Headquarters

2.7 Global Key Manufacturers of Semiconductor Wafer Blade Cutting Machine, Product Offered and Application

2.8 Global Key Manufacturers of Semiconductor Wafer Blade Cutting Machine, Date of Enter into This Industry

2.9 Semiconductor Wafer Blade Cutting Machine Market Competitive Situation and Trends

2.9.1 Semiconductor Wafer Blade Cutting Machine Market Concentration Rate

2.9.2 Global 5 and 10 Largest Semiconductor Wafer Blade Cutting Machine Players Market Share by Revenue

2.10 Mergers & Acquisitions, Expansion

### **3 SEMICONDUCTOR WAFER BLADE CUTTING MACHINE PRODUCTION BY REGION**

3.1 Global Semiconductor Wafer Blade Cutting Machine Production Value Estimates and Forecasts by Region: 2018 VS 2022 VS 2029

3.2 Global Semiconductor Wafer Blade Cutting Machine Production Value by Region (2018-2029)

3.2.1 Global Semiconductor Wafer Blade Cutting Machine Production Value Market Share by Region (2018-2023)

3.2.2 Global Forecasted Production Value of Semiconductor Wafer Blade Cutting Machine by Region (2024-2029)

3.3 Global Semiconductor Wafer Blade Cutting Machine Production Estimates and Forecasts by Region: 2018 VS 2022 VS 2029

3.4 Global Semiconductor Wafer Blade Cutting Machine Production by Region (2018-2029)

3.4.1 Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Region (2018-2023)

3.4.2 Global Forecasted Production of Semiconductor Wafer Blade Cutting Machine by Region (2024-2029)

3.5 Global Semiconductor Wafer Blade Cutting Machine Market Price Analysis by Region (2018-2023)

3.6 Global Semiconductor Wafer Blade Cutting Machine Production and Value, Year-over-Year Growth

3.6.1 North America Semiconductor Wafer Blade Cutting Machine Production Value Estimates and Forecasts (2018-2029)

3.6.2 Europe Semiconductor Wafer Blade Cutting Machine Production Value Estimates and Forecasts (2018-2029)

3.6.3 China Semiconductor Wafer Blade Cutting Machine Production Value Estimates and Forecasts (2018-2029)

3.6.4 Japan Semiconductor Wafer Blade Cutting Machine Production Value Estimates and Forecasts (2018-2029)

## **4 SEMICONDUCTOR WAFER BLADE CUTTING MACHINE CONSUMPTION BY REGION**

4.1 Global Semiconductor Wafer Blade Cutting Machine Consumption Estimates and Forecasts by Region: 2018 VS 2022 VS 2029

4.2 Global Semiconductor Wafer Blade Cutting Machine Consumption by Region (2018-2029)

4.2.1 Global Semiconductor Wafer Blade Cutting Machine Consumption by Region (2018-2023)

4.2.2 Global Semiconductor Wafer Blade Cutting Machine Forecasted Consumption by Region (2024-2029)

4.3 North America

4.3.1 North America Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Country: 2018 VS 2022 VS 2029

4.3.2 North America Semiconductor Wafer Blade Cutting Machine Consumption by Country (2018-2029)

4.3.3 United States

4.3.4 Canada

4.4 Europe

4.4.1 Europe Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Country: 2018 VS 2022 VS 2029

4.4.2 Europe Semiconductor Wafer Blade Cutting Machine Consumption by Country (2018-2029)

4.4.3 Germany

4.4.4 France

4.4.5 U.K.

4.4.6 Italy

4.4.7 Russia

4.5 Asia Pacific

4.5.1 Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption Growth



Rate by Region: 2018 VS 2022 VS 2029

4.5.2 Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption by Region (2018-2029)

4.5.3 China

4.5.4 Japan

4.5.5 South Korea

4.5.6 China Taiwan

4.5.7 Southeast Asia

4.5.8 India

4.6 Latin America, Middle East & Africa

4.6.1 Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Country: 2018 VS 2022 VS 2029

4.6.2 Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption by Country (2018-2029)

4.6.3 Mexico

4.6.4 Brazil

4.6.5 Turkey

## **5 SEGMENT BY TYPE**

5.1 Global Semiconductor Wafer Blade Cutting Machine Production by Type (2018-2029)

5.1.1 Global Semiconductor Wafer Blade Cutting Machine Production by Type (2018-2023)

5.1.2 Global Semiconductor Wafer Blade Cutting Machine Production by Type (2024-2029)

5.1.3 Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Type (2018-2029)

5.2 Global Semiconductor Wafer Blade Cutting Machine Production Value by Type (2018-2029)

5.2.1 Global Semiconductor Wafer Blade Cutting Machine Production Value by Type (2018-2023)

5.2.2 Global Semiconductor Wafer Blade Cutting Machine Production Value by Type (2024-2029)

5.2.3 Global Semiconductor Wafer Blade Cutting Machine Production Value Market Share by Type (2018-2029)

5.3 Global Semiconductor Wafer Blade Cutting Machine Price by Type (2018-2029)

## **6 SEGMENT BY APPLICATION**

## 6.1 Global Semiconductor Wafer Blade Cutting Machine Production by Application (2018-2029)

### 6.1.1 Global Semiconductor Wafer Blade Cutting Machine Production by Application (2018-2023)

### 6.1.2 Global Semiconductor Wafer Blade Cutting Machine Production by Application (2024-2029)

### 6.1.3 Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Application (2018-2029)

## 6.2 Global Semiconductor Wafer Blade Cutting Machine Production Value by Application (2018-2029)

### 6.2.1 Global Semiconductor Wafer Blade Cutting Machine Production Value by Application (2018-2023)

### 6.2.2 Global Semiconductor Wafer Blade Cutting Machine Production Value by Application (2024-2029)

### 6.2.3 Global Semiconductor Wafer Blade Cutting Machine Production Value Market Share by Application (2018-2029)

## 6.3 Global Semiconductor Wafer Blade Cutting Machine Price by Application (2018-2029)

## 7 KEY COMPANIES PROFILED

### 7.1 DISCO

#### 7.1.1 DISCO Semiconductor Wafer Blade Cutting Machine Corporation Information

#### 7.1.2 DISCO Semiconductor Wafer Blade Cutting Machine Product Portfolio

#### 7.1.3 DISCO Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

#### 7.1.4 DISCO Main Business and Markets Served

#### 7.1.5 DISCO Recent Developments/Updates

### 7.2 Tokyo Seimitsu

#### 7.2.1 Tokyo Seimitsu Semiconductor Wafer Blade Cutting Machine Corporation Information

#### 7.2.2 Tokyo Seimitsu Semiconductor Wafer Blade Cutting Machine Product Portfolio

#### 7.2.3 Tokyo Seimitsu Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

#### 7.2.4 Tokyo Seimitsu Main Business and Markets Served

#### 7.2.5 Tokyo Seimitsu Recent Developments/Updates

### 7.3 GL Tech Co Ltd

#### 7.3.1 GL Tech Co Ltd Semiconductor Wafer Blade Cutting Machine Corporation

## Information

7.3.2 GL Tech Co Ltd Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.3.3 GL Tech Co Ltd Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.3.4 GL Tech Co Ltd Main Business and Markets Served

7.3.5 GL Tech Co Ltd Recent Developments/Updates

## 7.4 ASM

7.4.1 ASM Semiconductor Wafer Blade Cutting Machine Corporation Information

7.4.2 ASM Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.4.3 ASM Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.4.4 ASM Main Business and Markets Served

7.4.5 ASM Recent Developments/Updates

## 7.5 Synova

7.5.1 Synova Semiconductor Wafer Blade Cutting Machine Corporation Information

7.5.2 Synova Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.5.3 Synova Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.5.4 Synova Main Business and Markets Served

7.5.5 Synova Recent Developments/Updates

## 7.6 CETC Electronics Equipment Group Co., Ltd.

7.6.1 CETC Electronics Equipment Group Co., Ltd. Semiconductor Wafer Blade Cutting Machine Corporation Information

7.6.2 CETC Electronics Equipment Group Co., Ltd. Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.6.3 CETC Electronics Equipment Group Co., Ltd. Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.6.4 CETC Electronics Equipment Group Co., Ltd. Main Business and Markets Served

7.6.5 CETC Electronics Equipment Group Co., Ltd. Recent Developments/Updates

## 7.7 Shenyang Heyan Technology Co., Ltd.

7.7.1 Shenyang Heyan Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Corporation Information

7.7.2 Shenyang Heyan Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.7.3 Shenyang Heyan Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.7.4 Shenyang Heyan Technology Co., Ltd. Main Business and Markets Served

7.7.5 Shenyang Heyan Technology Co., Ltd. Recent Developments/Updates

## 7.8 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd.

7.8.1 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Corporation Information

7.8.2 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.8.3 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.8.4 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Main Business and Markets Served

7.7.5 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Recent Developments/Updates

## 7.9 Hi-TESI

7.9.1 Hi-TESI Semiconductor Wafer Blade Cutting Machine Corporation Information

7.9.2 Hi-TESI Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.9.3 Hi-TESI Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.9.4 Hi-TESI Main Business and Markets Served

7.9.5 Hi-TESI Recent Developments/Updates

## 7.10 Tensun

7.10.1 Tensun Semiconductor Wafer Blade Cutting Machine Corporation Information

7.10.2 Tensun Semiconductor Wafer Blade Cutting Machine Product Portfolio

7.10.3 Tensun Semiconductor Wafer Blade Cutting Machine Production, Value, Price and Gross Margin (2018-2023)

7.10.4 Tensun Main Business and Markets Served

7.10.5 Tensun Recent Developments/Updates

## **8 INDUSTRY CHAIN AND SALES CHANNELS ANALYSIS**

8.1 Semiconductor Wafer Blade Cutting Machine Industry Chain Analysis

8.2 Semiconductor Wafer Blade Cutting Machine Key Raw Materials

8.2.1 Key Raw Materials

8.2.2 Raw Materials Key Suppliers

8.3 Semiconductor Wafer Blade Cutting Machine Production Mode & Process

8.4 Semiconductor Wafer Blade Cutting Machine Sales and Marketing

8.4.1 Semiconductor Wafer Blade Cutting Machine Sales Channels

8.4.2 Semiconductor Wafer Blade Cutting Machine Distributors

8.5 Semiconductor Wafer Blade Cutting Machine Customers

## **9 SEMICONDUCTOR WAFER BLADE CUTTING MACHINE MARKET DYNAMICS**

- 9.1 Semiconductor Wafer Blade Cutting Machine Industry Trends
- 9.2 Semiconductor Wafer Blade Cutting Machine Market Drivers
- 9.3 Semiconductor Wafer Blade Cutting Machine Market Challenges
- 9.4 Semiconductor Wafer Blade Cutting Machine Market Restraints

## **10 RESEARCH FINDING AND CONCLUSION**

## **11 METHODOLOGY AND DATA SOURCE**

- 11.1 Methodology/Research Approach
  - 11.1.1 Research Programs/Design
  - 11.1.2 Market Size Estimation
  - 11.1.3 Market Breakdown and Data Triangulation
- 11.2 Data Source
  - 11.2.1 Secondary Sources
  - 11.2.2 Primary Sources
- 11.3 Author List
- 11.4 Disclaimer

## List Of Tables

### LIST OF TABLES

Table 1. Global Semiconductor Wafer Blade Cutting Machine Market Value by Type, (US\$ Million) & (2022 VS 2029)

Table 2. Global Semiconductor Wafer Blade Cutting Machine Market Value by Application, (US\$ Million) & (2022 VS 2029)

Table 3. Global Semiconductor Wafer Blade Cutting Machine Production Capacity (K Units) by Manufacturers in 2022

Table 4. Global Semiconductor Wafer Blade Cutting Machine Production by Manufacturers (2018-2023) & (K Units)

Table 5. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Manufacturers (2018-2023)

Table 6. Global Semiconductor Wafer Blade Cutting Machine Production Value by Manufacturers (2018-2023) & (US\$ Million)

Table 7. Global Semiconductor Wafer Blade Cutting Machine Production Value Share by Manufacturers (2018-2023)

Table 8. Global Semiconductor Wafer Blade Cutting Machine Industry Ranking 2021 VS 2022 VS 2023

Table 9. Company Type (Tier 1, Tier 2 and Tier 3) & (based on the Revenue in Semiconductor Wafer Blade Cutting Machine as of 2022)

Table 10. Global Market Semiconductor Wafer Blade Cutting Machine Average Price by Manufacturers (US\$/Unit) & (2018-2023)

Table 11. Manufacturers Semiconductor Wafer Blade Cutting Machine Production Sites and Area Served

Table 12. Manufacturers Semiconductor Wafer Blade Cutting Machine Product Types

Table 13. Global Semiconductor Wafer Blade Cutting Machine Manufacturers Market Concentration Ratio (CR5 and HHI)

Table 14. Mergers & Acquisitions, Expansion

Table 15. Global Semiconductor Wafer Blade Cutting Machine Production Value by Region: 2018 VS 2022 VS 2029 (US\$ Million)

Table 16. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) by Region (2018-2023)

Table 17. Global Semiconductor Wafer Blade Cutting Machine Production Value Market Share by Region (2018-2023)

Table 18. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) Forecast by Region (2024-2029)

Table 19. Global Semiconductor Wafer Blade Cutting Machine Production Value Market

Share Forecast by Region (2024-2029)

Table 20. Global Semiconductor Wafer Blade Cutting Machine Production Comparison by Region: 2018 VS 2022 VS 2029 (K Units)

Table 21. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) by Region (2018-2023)

Table 22. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Region (2018-2023)

Table 23. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) Forecast by Region (2024-2029)

Table 24. Global Semiconductor Wafer Blade Cutting Machine Production Market Share Forecast by Region (2024-2029)

Table 25. Global Semiconductor Wafer Blade Cutting Machine Market Average Price (US\$/Unit) by Region (2018-2023)

Table 26. Global Semiconductor Wafer Blade Cutting Machine Market Average Price (US\$/Unit) by Region (2024-2029)

Table 27. Global Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Region: 2018 VS 2022 VS 2029 (K Units)

Table 28. Global Semiconductor Wafer Blade Cutting Machine Consumption by Region (2018-2023) & (K Units)

Table 29. Global Semiconductor Wafer Blade Cutting Machine Consumption Market Share by Region (2018-2023)

Table 30. Global Semiconductor Wafer Blade Cutting Machine Forecasted Consumption by Region (2024-2029) & (K Units)

Table 31. Global Semiconductor Wafer Blade Cutting Machine Forecasted Consumption Market Share by Region (2018-2023)

Table 32. North America Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Country: 2018 VS 2022 VS 2029 (K Units)

Table 33. North America Semiconductor Wafer Blade Cutting Machine Consumption by Country (2018-2023) & (K Units)

Table 34. North America Semiconductor Wafer Blade Cutting Machine Consumption by Country (2024-2029) & (K Units)

Table 35. Europe Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Country: 2018 VS 2022 VS 2029 (K Units)

Table 36. Europe Semiconductor Wafer Blade Cutting Machine Consumption by Country (2018-2023) & (K Units)

Table 37. Europe Semiconductor Wafer Blade Cutting Machine Consumption by Country (2024-2029) & (K Units)

Table 38. Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Region: 2018 VS 2022 VS 2029 (K Units)

Table 39. Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption by Region (2018-2023) & (K Units)

Table 40. Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption by Region (2024-2029) & (K Units)

Table 41. Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption Growth Rate by Country: 2018 VS 2022 VS 2029 (K Units)

Table 42. Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption by Country (2018-2023) & (K Units)

Table 43. Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption by Country (2024-2029) & (K Units)

Table 44. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) by Type (2018-2023)

Table 45. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) by Type (2024-2029)

Table 46. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Type (2018-2023)

Table 47. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Type (2024-2029)

Table 48. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) by Type (2018-2023)

Table 49. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) by Type (2024-2029)

Table 50. Global Semiconductor Wafer Blade Cutting Machine Production Value Share by Type (2018-2023)

Table 51. Global Semiconductor Wafer Blade Cutting Machine Production Value Share by Type (2024-2029)

Table 52. Global Semiconductor Wafer Blade Cutting Machine Price (US\$/Unit) by Type (2018-2023)

Table 53. Global Semiconductor Wafer Blade Cutting Machine Price (US\$/Unit) by Type (2024-2029)

Table 54. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) by Application (2018-2023)

Table 55. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) by Application (2024-2029)

Table 56. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Application (2018-2023)

Table 57. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Application (2024-2029)

Table 58. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$



Million) by Application (2018-2023)

Table 59. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) by Application (2024-2029)

Table 60. Global Semiconductor Wafer Blade Cutting Machine Production Value Share by Application (2018-2023)

Table 61. Global Semiconductor Wafer Blade Cutting Machine Production Value Share by Application (2024-2029)

Table 62. Global Semiconductor Wafer Blade Cutting Machine Price (US\$/Unit) by Application (2018-2023)

Table 63. Global Semiconductor Wafer Blade Cutting Machine Price (US\$/Unit) by Application (2024-2029)

Table 64. DISCO Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 65. DISCO Specification and Application

Table 66. DISCO Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 67. DISCO Main Business and Markets Served

Table 68. DISCO Recent Developments/Updates

Table 69. Tokyo Seimitsu Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 70. Tokyo Seimitsu Specification and Application

Table 71. Tokyo Seimitsu Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 72. Tokyo Seimitsu Main Business and Markets Served

Table 73. Tokyo Seimitsu Recent Developments/Updates

Table 74. GL Tech Co Ltd Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 75. GL Tech Co Ltd Specification and Application

Table 76. GL Tech Co Ltd Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 77. GL Tech Co Ltd Main Business and Markets Served

Table 78. GL Tech Co Ltd Recent Developments/Updates

Table 79. ASM Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 80. ASM Specification and Application

Table 81. ASM Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 82. ASM Main Business and Markets Served

Table 83. ASM Recent Developments/Updates

Table 84. Synova Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 85. Synova Specification and Application

Table 86. Synova Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 87. Synova Main Business and Markets Served

Table 88. Synova Recent Developments/Updates

Table 89. CETC Electronics Equipment Group Co., Ltd. Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 90. CETC Electronics Equipment Group Co., Ltd. Specification and Application

Table 91. CETC Electronics Equipment Group Co., Ltd. Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 92. CETC Electronics Equipment Group Co., Ltd. Main Business and Markets Served

Table 93. CETC Electronics Equipment Group Co., Ltd. Recent Developments/Updates

Table 94. Shenyang Heyan Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 95. Shenyang Heyan Technology Co., Ltd. Specification and Application

Table 96. Shenyang Heyan Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 97. Shenyang Heyan Technology Co., Ltd. Main Business and Markets Served

Table 98. Shenyang Heyan Technology Co., Ltd. Recent Developments/Updates

Table 99. Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 100. Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Specification and Application

Table 101. Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 102. Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Main Business and Markets Served

Table 103. Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Recent Developments/Updates

Table 104. Hi-TESI Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 105. Hi-TESI Specification and Application

Table 106. Hi-TESI Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 107. Hi-TESI Main Business and Markets Served

Table 108. Hi-TESI Recent Developments/Updates

Table 109. Tensun Semiconductor Wafer Blade Cutting Machine Corporation Information

Table 110. Tensun Specification and Application

Table 111. Tensun Semiconductor Wafer Blade Cutting Machine Production (K Units), Value (US\$ Million), Price (US\$/Unit) and Gross Margin (2018-2023)

Table 112. Tensun Main Business and Markets Served

Table 113. Tensun Recent Developments/Updates

Table 114. Key Raw Materials Lists

Table 115. Raw Materials Key Suppliers Lists

Table 116. Semiconductor Wafer Blade Cutting Machine Distributors List

Table 117. Semiconductor Wafer Blade Cutting Machine Customers List

Table 118. Semiconductor Wafer Blade Cutting Machine Market Trends

Table 119. Semiconductor Wafer Blade Cutting Machine Market Drivers

Table 120. Semiconductor Wafer Blade Cutting Machine Market Challenges

Table 121. Semiconductor Wafer Blade Cutting Machine Market Restraints

Table 122. Research Programs/Design for This Report

Table 123. Key Data Information from Secondary Sources

Table 124. Key Data Information from Primary Sources

## List Of Figures

### LIST OF FIGURES

- Figure 1. Product Picture of Semiconductor Wafer Blade Cutting Machine
- Figure 2. Global Semiconductor Wafer Blade Cutting Machine Market Value by Type, (US\$ Million) & (2022 VS 2029)
- Figure 3. Global Semiconductor Wafer Blade Cutting Machine Market Share by Type: 2022 VS 2029
- Figure 4. 150mm Wafer Product Picture
- Figure 5. 200mm Wafer Product Picture
- Figure 6. 300mm Wafer Product Picture
- Figure 7. Global Semiconductor Wafer Blade Cutting Machine Market Value by Application, (US\$ Million) & (2022 VS 2029)
- Figure 8. Global Semiconductor Wafer Blade Cutting Machine Market Share by Application: 2022 VS 2029
- Figure 9. Pure Foundry
- Figure 10. IDM
- Figure 11. OSAT
- Figure 12. LED
- Figure 13. Photovoltaic
- Figure 14. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million), 2018 VS 2022 VS 2029
- Figure 15. Global Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) & (2018-2029)
- Figure 16. Global Semiconductor Wafer Blade Cutting Machine Production (K Units) & (2018-2029)
- Figure 17. Global Semiconductor Wafer Blade Cutting Machine Average Price (US\$/Unit) & (2018-2029)
- Figure 18. Semiconductor Wafer Blade Cutting Machine Report Years Considered
- Figure 19. Semiconductor Wafer Blade Cutting Machine Production Share by Manufacturers in 2022
- Figure 20. Semiconductor Wafer Blade Cutting Machine Market Share by Company Type (Tier 1, Tier 2, and Tier 3): 2018 VS 2022
- Figure 21. The Global 5 and 10 Largest Players: Market Share by Semiconductor Wafer Blade Cutting Machine Revenue in 2022
- Figure 22. Global Semiconductor Wafer Blade Cutting Machine Production Value by Region: 2018 VS 2022 VS 2029 (US\$ Million)
- Figure 23. Global Semiconductor Wafer Blade Cutting Machine Production Value

Market Share by Region: 2018 VS 2022 VS 2029

Figure 24. Global Semiconductor Wafer Blade Cutting Machine Production Comparison by Region: 2018 VS 2022 VS 2029 (K Units)

Figure 25. Global Semiconductor Wafer Blade Cutting Machine Production Market Share by Region: 2018 VS 2022 VS 2029

Figure 26. North America Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) Growth Rate (2018-2029)

Figure 27. Europe Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) Growth Rate (2018-2029)

Figure 28. China Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) Growth Rate (2018-2029)

Figure 29. Japan Semiconductor Wafer Blade Cutting Machine Production Value (US\$ Million) Growth Rate (2018-2029)

Figure 30. Global Semiconductor Wafer Blade Cutting Machine Consumption by Region: 2018 VS 2022 VS 2029 (K Units)

Figure 31. Global Semiconductor Wafer Blade Cutting Machine Consumption Market Share by Region: 2018 VS 2022 VS 2029

Figure 32. North America Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 33. North America Semiconductor Wafer Blade Cutting Machine Consumption Market Share by Country (2018-2029)

Figure 34. Canada Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 35. U.S. Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 36. Europe Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 37. Europe Semiconductor Wafer Blade Cutting Machine Consumption Market Share by Country (2018-2029)

Figure 38. Germany Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 39. France Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 40. U.K. Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 41. Italy Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

Figure 42. Russia Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)

- Figure 43. Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 44. Asia Pacific Semiconductor Wafer Blade Cutting Machine Consumption Market Share by Regions (2018-2029)
- Figure 45. China Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 46. Japan Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 47. South Korea Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 48. China Taiwan Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 49. Southeast Asia Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 50. India Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 51. Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 52. Latin America, Middle East & Africa Semiconductor Wafer Blade Cutting Machine Consumption Market Share by Country (2018-2029)
- Figure 53. Mexico Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 54. Brazil Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 55. Turkey Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 56. GCC Countries Semiconductor Wafer Blade Cutting Machine Consumption and Growth Rate (2018-2023) & (K Units)
- Figure 57. Global Production Market Share of Semiconductor Wafer Blade Cutting Machine by Type (2018-2029)
- Figure 58. Global Production Value Market Share of Semiconductor Wafer Blade Cutting Machine by Type (2018-2029)
- Figure 59. Global Semiconductor Wafer Blade Cutting Machine Price (US\$/Unit) by Type (2018-2029)
- Figure 60. Global Production Market Share of Semiconductor Wafer Blade Cutting Machine by Application (2018-2029)
- Figure 61. Global Production Value Market Share of Semiconductor Wafer Blade Cutting Machine by Application (2018-2029)
- Figure 62. Global Semiconductor Wafer Blade Cutting Machine Price (US\$/Unit) by

Application (2018-2029)

Figure 63. Semiconductor Wafer Blade Cutting Machine Value Chain

Figure 64. Semiconductor Wafer Blade Cutting Machine Production Process

Figure 65. Channels of Distribution (Direct Vs Distribution)

Figure 66. Distributors Profiles

Figure 67. Bottom-up and Top-down Approaches for This Report

Figure 68. Data Triangulation

## I would like to order

Product name: Global Semiconductor Wafer Blade Cutting Machine Market Research Report 2023

Product link: <https://marketpublishers.com/r/G873E9EA5E75EN.html>

Price: US\$ 2,900.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

[info@marketpublishers.com](mailto:info@marketpublishers.com)

## Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/G873E9EA5E75EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:  
Last name:  
Email:  
Company:  
Address:  
City:  
Zip code:  
Country:  
Tel:  
Fax:  
Your message:

**\*\*All fields are required**

Customer signature \_\_\_\_\_

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970